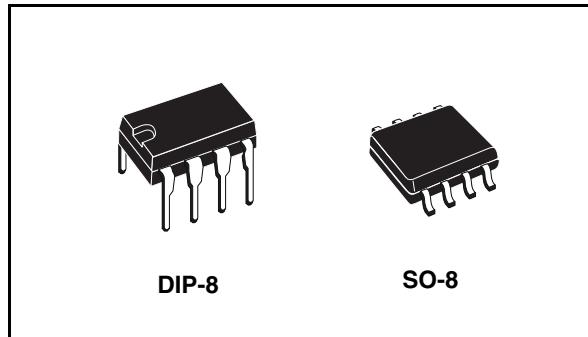


3.3V Step down current mode PWM DC-DC converters

Feature summary

- Output voltage 3.3V
- Supply voltage range from 3.3V to 11V
- Guaranteed output current: 500mA
- Typical operation frequency: 200KHz
- Very low quiescent current: 0.6mA on mode 0.2 μ A OFF MODE
- Switch ON/OFF control
- Typical efficiency: 90%
- Operating temperature range: -40°C TO 85°C
- Available in SO-8 and DIP-8 packages



variations. A minimum number of external components is used and the fixed frequency switching allows easy filtering of output ripple and noise.

Other features of this device are cycle-by-cycle current limiting, overcurrent limiting, under voltage lockout and programmable soft-start protection.

A 22 μ H inductor works in most applications, so no sophisticated design is necessary.

Package available are SO-8 and DIP-8.

Typical application are in 5V to 3.3V converters, cellular phones, portable instruments, hand-held computers, and peripherals.

Description

The ST763A is a step-down switching regulator. It operates from 3.3V to 11V giving a fixed 3.3V output voltage, delivering up to 500mA. The main features are typical efficiency of 90%, quiescent current of 0.6mA, and only 0.2 μ A in shut-down.

The PWM current mode control provides precise output regulation and very good transient response. Output voltage accuracy is guaranteed to be $\pm 5\%$ over line, load and temperature

Order code

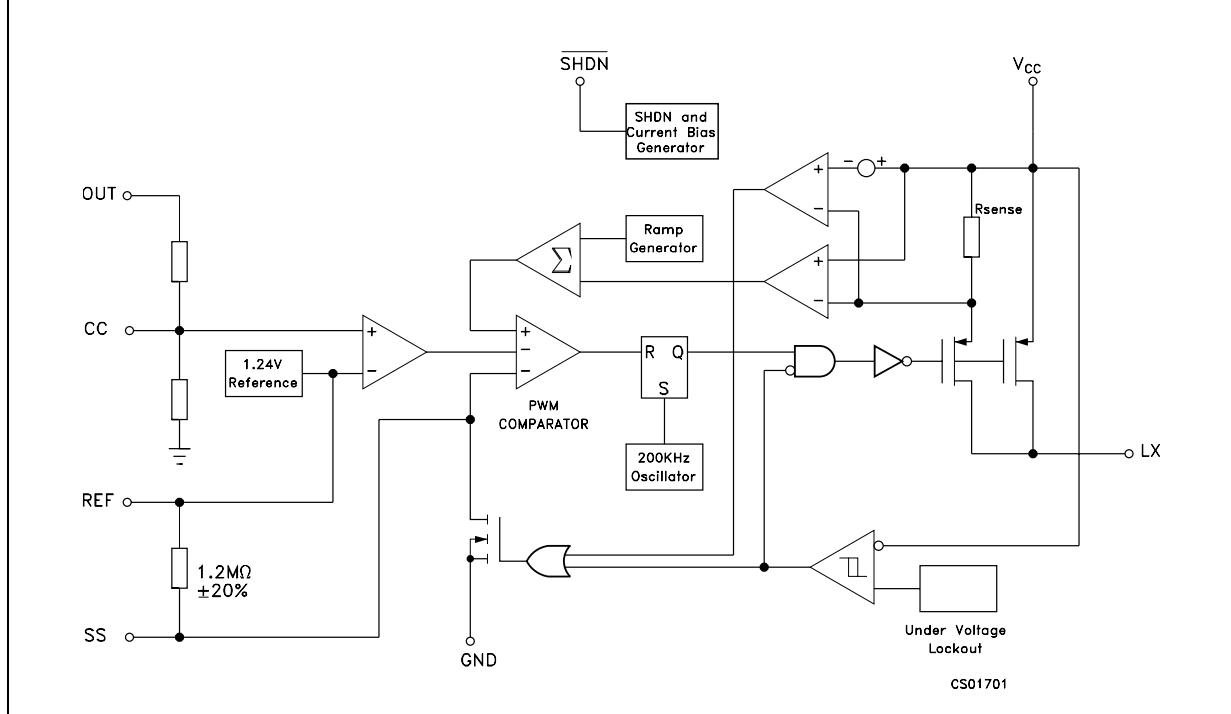
Part number	Package		Packaging
	DIP-8	SO-8	
ST763AB	ST763ABN	ST763ABD	ST763ABDTR
ST763AC	ST763ACN	ST763ACD	ST763ACDTR

Contents

1	Diagram	3
2	Pin configuration	4
3	Maximum ratings	5
4	Typical application	6
5	Electrical characteristics	7
6	Typical performance characteristics	8
7	Package mechanical data	11
8	Revision history	15

1 Diagram

Figure 1. Schematic diagram



2 Pin configuration

Figure 2. Pin connections (top view)

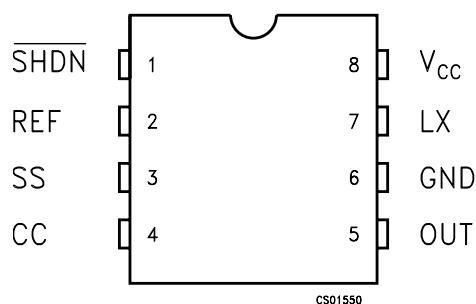


Table 1. Pin description

Pin N°	Symbol	Name and function
1	SHDN	Shutdown control (active low): If connected to GND the IC is in shutdown. Connect to V _{CC} for normal operation (ON MODE).
2	REF	Reference output voltage: (1.25V): Bypass to GND with 47nF capacitor.
3	SS	Soft start: a capacitor between SS and GND provides soft-start and short-circuit protections.
4	CC	Compensation capacitor input: externally compensates the outer (voltage) feedback loop. Connect to OUT with 330pF capacitor
5	OUT	Output voltage sense input: provides regulation of feedback sensing. Connect to 3.3V output.
6	GND	Ground
7	LX	Switch output. Drain of internal P-Channel Power MOSFET
8	V_{CC}	Supply voltage input. Bypass to GND with 1μF ceramic capacitance and large value electrolytic capacitor in parallel. The 1μF capacitor must be as close as possible to the GND and V _{CC} pins.

3 Maximum ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}	DC Input voltage	-0.3 to 12	V
V_{LX}	Switch pin voltage	-0.3 to ($V_{CC} + 0.3$)	V
V_{SHDN}	Shutdown voltage (SHDN)	-0.3 to ($V_{CC} + 0.3$)	V
V_S, V_C	Soft start (SS) and compensation capacitor (CC) pins voltage	-0.3 to ($V_{CC} + 0.3$)	V
I_{LX}	Switching peak current	2	A
I_{REF}	Reference current	2.5	mA
P_{TOT}	Continuous power dissipation at $T_A=70^\circ\text{C}$	DIP-8	550
		SO-8	344
T_{stg}	Storage temperature range	-40 to +150	$^\circ\text{C}$
T_{op}	Operating junction temperature range	AC series	0 to +70
		AB series	-40 to +85

Note: *Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied*

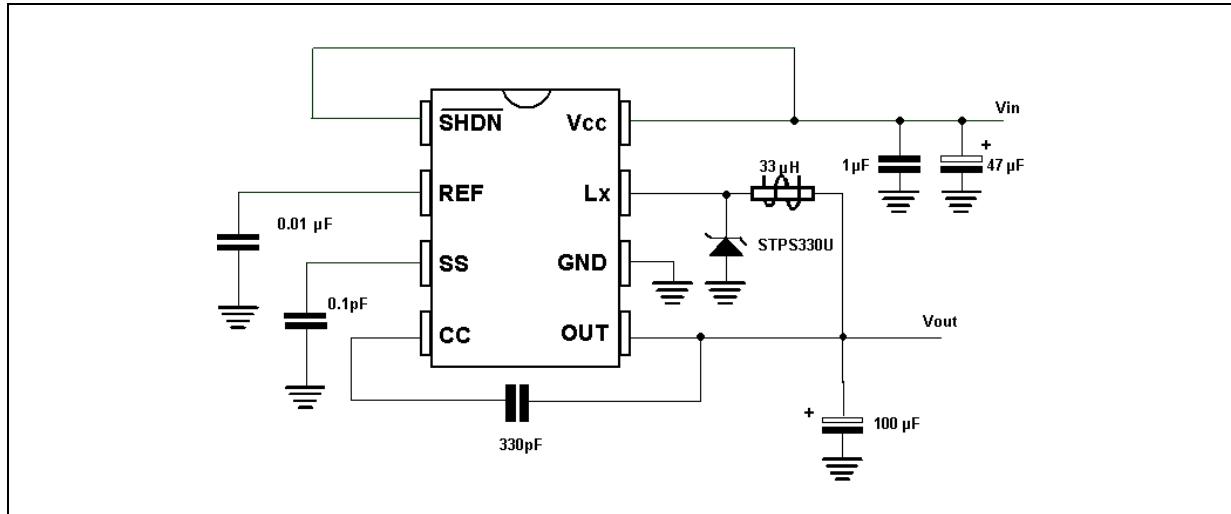
Table 3. Thermal data

Symbol	Parameter	SO-8	DIP-8	Unit
R_{thJA}	Thermal resistance junction-ambient ⁽¹⁾	160	100	$^\circ\text{C/W}$

1. This value depends from thermal design of PCB on which the device is mounted.

4 Typical application

Figure 3. Application circuit



5 Electrical characteristics

Table 4. Electrical characteristics

($V_{CC}=5V$, $I_O = 0mA$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise specified).

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_{CC}	Input voltage		3.3		11	V
V_O	Output voltage	$V_{CC} = 4$ to $11V$, $I_O = 0$ to $300mA$	3.135	3.3	3.465	V
		$V_{CC} = 4.75$ to $11V$, $I_O = 0$ to $500mA$	3.135	3.3	3.465	V
ΔV_O	Line regulation			0.13		%/V
ΔV_O	Load regulation	$I_O = 0$ to $500mA$		0.005		%/mA
η	Power efficiency	$I_O = 300mA$		88		%
		$I_O = 100mA$		90		
I_{SUPPLY}	Supply current	ON Mode (Including switch current)		0.6	2.5	mA
		OFF Mode		0.2	100	μA
V_{IH}	SHDN Input high threshold		2			V
V_{IL}	SHDN Input low threshold				0.25	V
I_{SHDN}	Shutdown input leakage current				1	μA
V_{LOCK}	Under voltage lockout	V_{CC} Falling		2.7	3	V
$R_{DS(on)}$	LX On resistance	$I_{LX} = 500mA$		1		Ω
I_{LEAK}	LX Leakage current	$V_{CC} = 12V$, $V_{LX} = 0V$		10		nA
V_{REF}	Reference voltage	$T_A = 25^\circ C$	1.18	1.25	1.32	V
ΔV_{REF}	Temperature reference drift	$T_A = T_{MIN}$ to T_{MAX}		50		ppm/ $^\circ C$
f_{OSC}	Switching frequency	$T_A = 25^\circ C$	159	200	212.5	KHz
R_C	Compensation pin impedance			7500		Ω

6 Typical performance characteristics

(Unless otherwise specified $T_J = 25^\circ\text{C}$)

Figure 4. Output voltage vs temperature

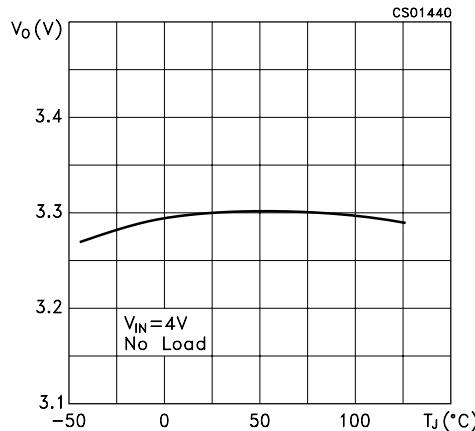


Figure 5. Output voltage vs input voltage

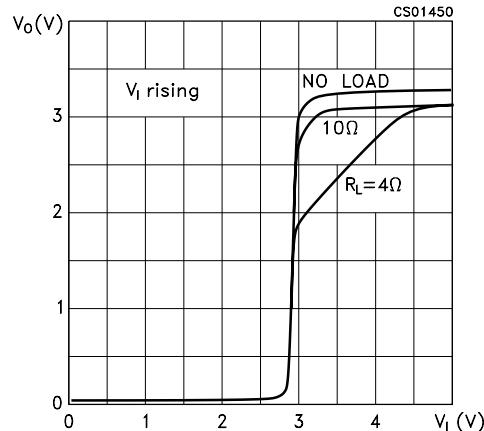


Figure 6. Reference voltage vs temperature

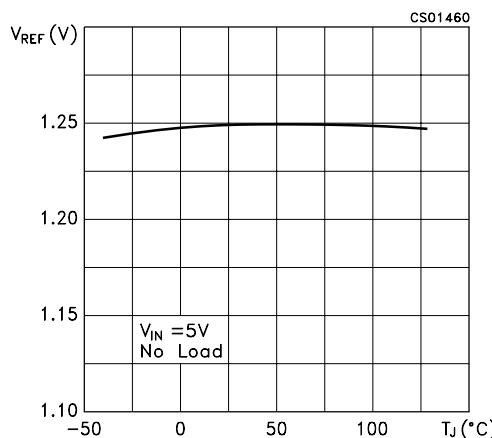


Figure 7. Efficiency vs temperature

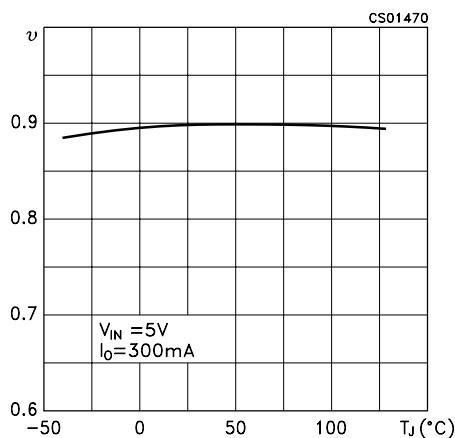


Figure 8. Efficiency vs output current

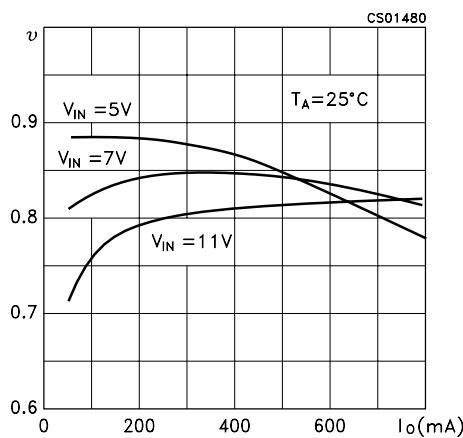


Figure 9. LX leakage current vs temperature

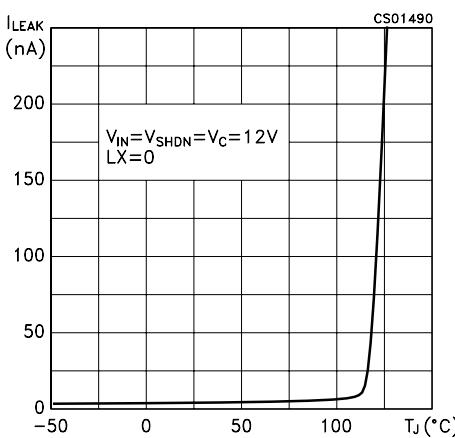


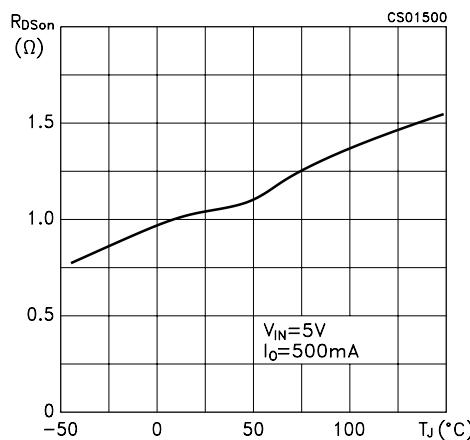
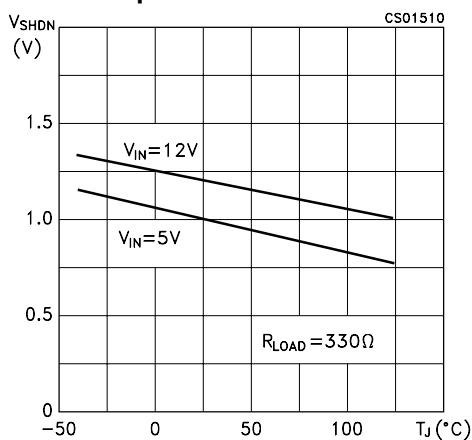
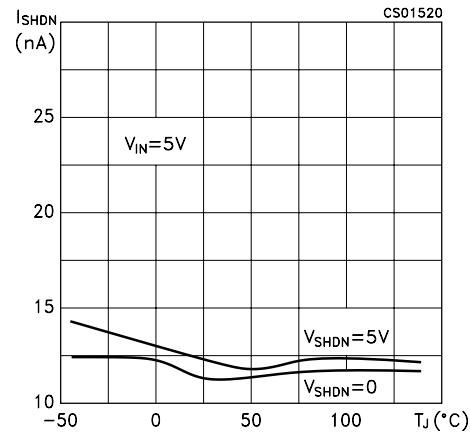
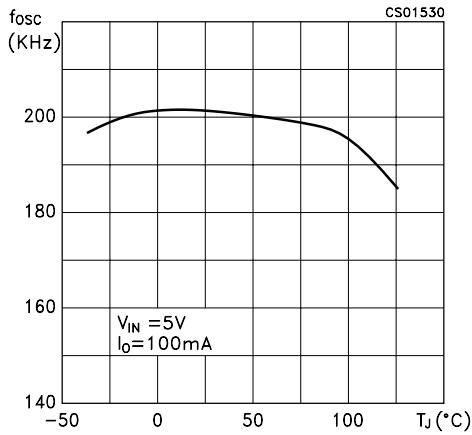
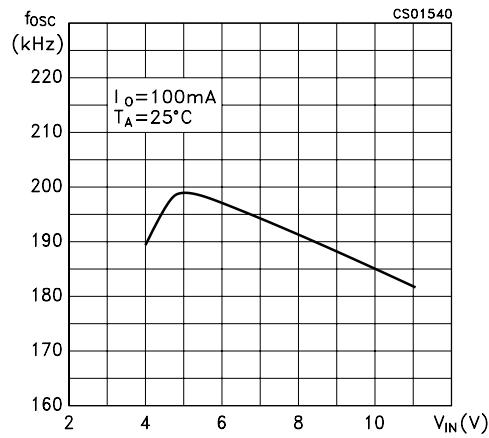
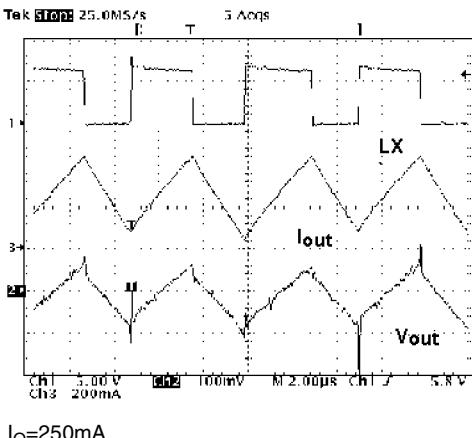
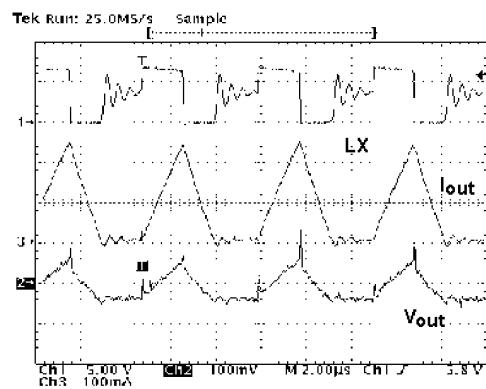
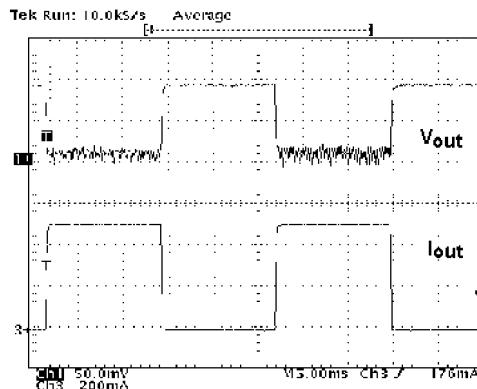
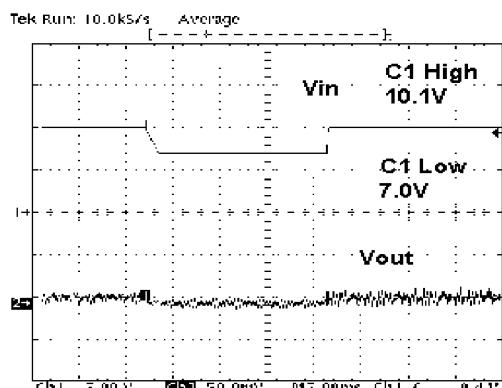
Figure 10. LX ON Resistance vs temperature**Figure 11. Shutdown input threshold vs temperature****Figure 12. Shutdown input leakage current vs temperature****Figure 13. Oscillator frequency vs temperature****Figure 14. Oscillator frequency vs input voltage****Figure 15. Switching waveform, continuous conduction**

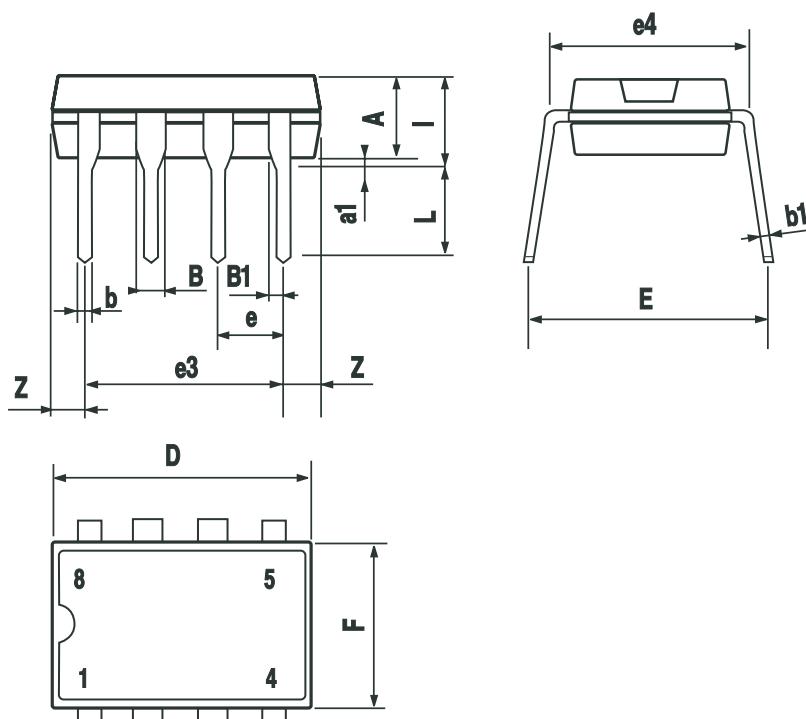
Figure 16. Switching waveform, discontinuous conduction $V_I=6V, I_O=75mA$ **Figure 17. Load transient** $V_I=5V, I_O=0 \text{ to } 500mA$ **Figure 18. Line transient** $I_O=350mA$

7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Plastic DIP-8 MECHANICAL DATA

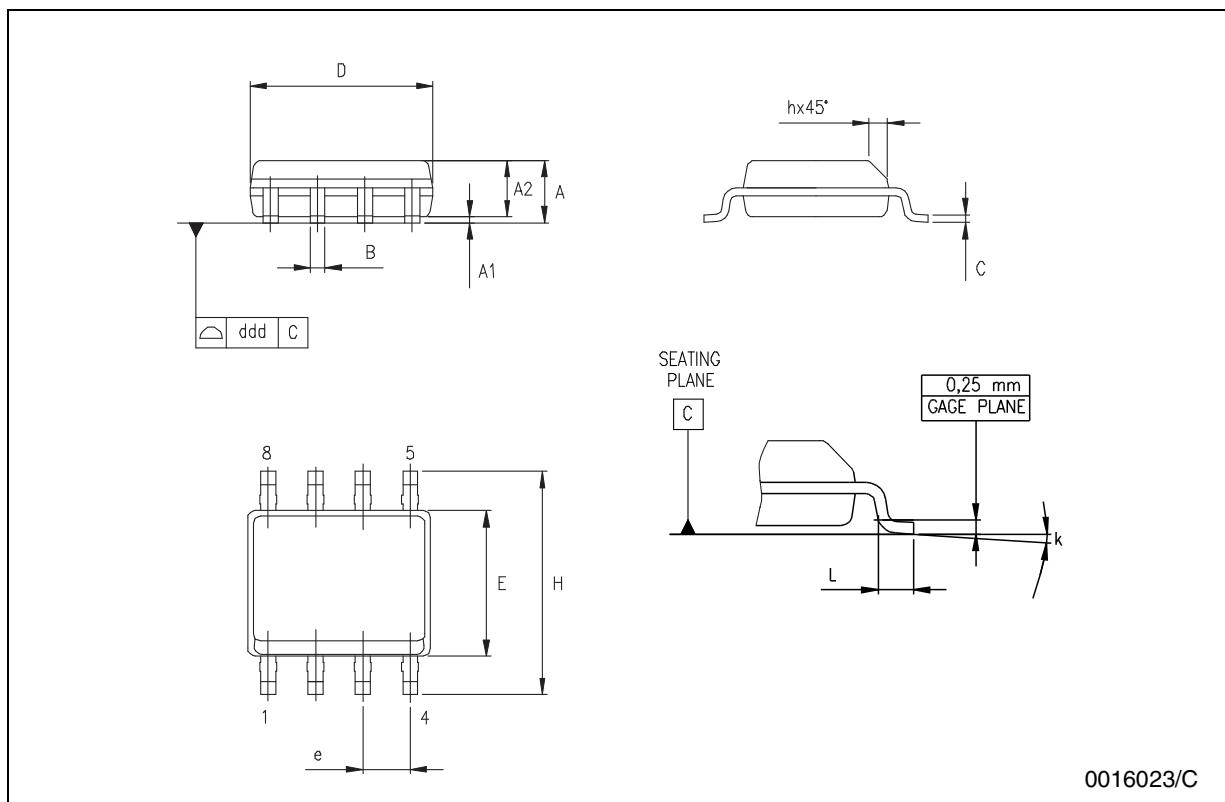
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A		3.3			0.130	
a1	0.7			0.028		
B	1.39		1.65	0.055		0.065
B1	0.91		1.04	0.036		0.041
b		0.5			0.020	
b1	0.38		0.5	0.015		0.020
D			9.8			0.386
E		8.8			0.346	
e		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			7.1			0.280
I			4.8			0.189
L		3.3			0.130	
Z	0.44		1.6	0.017		0.063



P001F

SO-8 MECHANICAL DATA

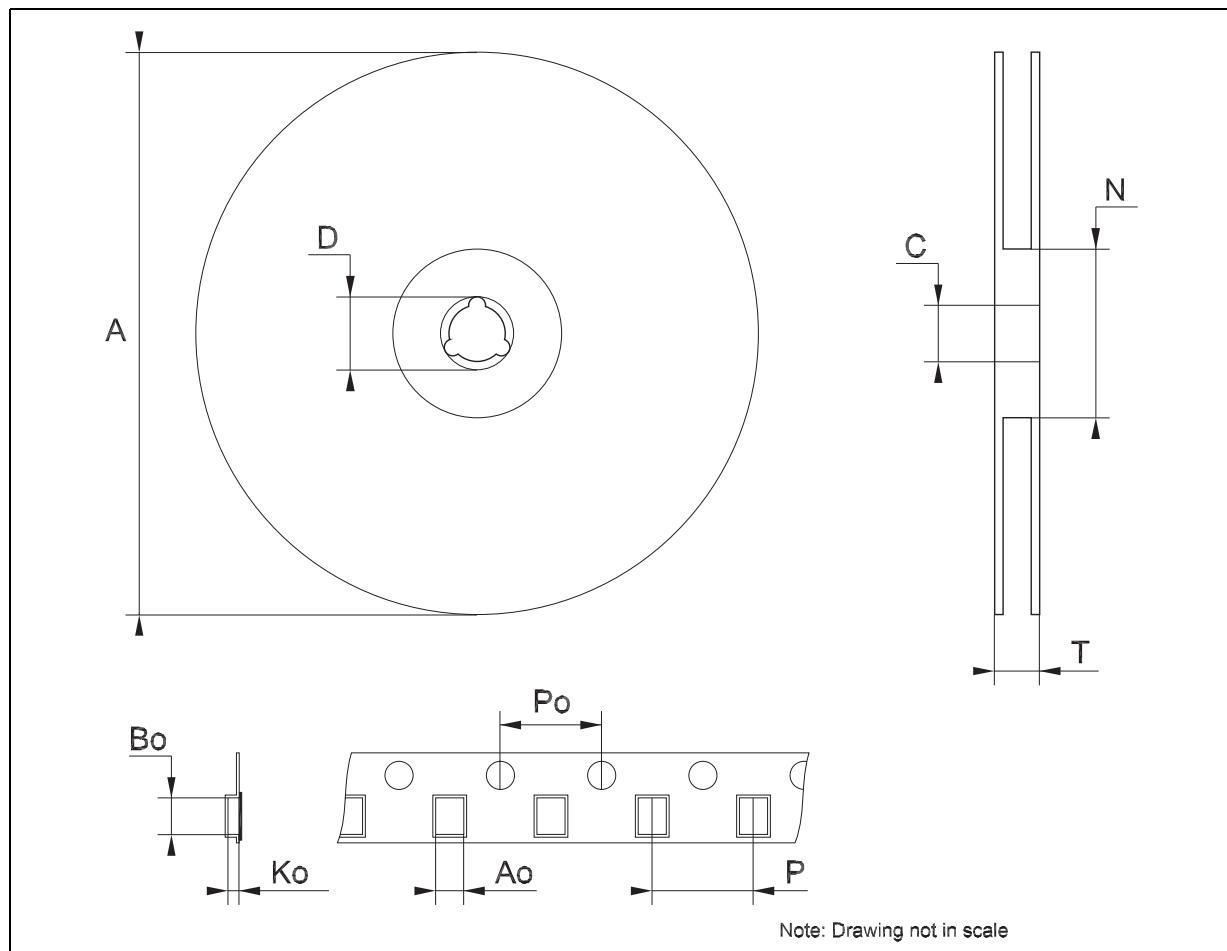
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	1.35		1.75	0.053		0.069
A1	0.10		0.25	0.04		0.010
A2	1.10		1.65	0.043		0.065
B	0.33		0.51	0.013		0.020
C	0.19		0.25	0.007		0.010
D	4.80		5.00	0.189		0.197
E	3.80		4.00	0.150		0.157
e		1.27			0.050	
H	5.80		6.20	0.228		0.244
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	8° (max.)					
ddd			0.1			0.04



0016023/C

Tape & Reel SO-8 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			22.4			0.882
Ao	8.1		8.5	0.319		0.335
Bo	5.5		5.9	0.216		0.232
Ko	2.1		2.3	0.082		0.090
Po	3.9		4.1	0.153		0.161
P	7.9		8.1	0.311		0.319



8 Revision history

Table 5. Revision history

Date	Revision	Changes
26-May-2006	2	Add T_A row f_{OSC} on table 4 and new template.

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